

2019 IEEE MTT-S International Microwave Conference on Hardware and Systems for 5G and Beyond (IMC-5G 2019)

**Atlanta, Georgia, USA
15-16 August 2019**



**IEEE Catalog Number: CFP19N66-POD
ISBN: 978-1-7281-3144-3**

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IEEE Catalog Number:	CFP19N66-POD
ISBN (Print-On-Demand):	978-1-7281-3144-3
ISBN (Online):	978-1-7281-3143-6

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Table of Contents

Opening Session

Chair: Hua Wang, Georgia Institute of Technology, USA Date: Thursday, 15th August 2019

Opening Remarks by Conference Chair

H. Wang
Georgia Inst. of Technology, USA

Keynote Talk 1 09:00-09:35

5G Evolution and Beyond

Christopher Hull
Intel Corporation, USA

08:45-09:00

Session 1: Advanced Systems and Networking Technologies

Chair: S. Bowers, University of Virginia, USA Date: Thursday, 15th August 2019

S1-1 09:50-10:15

Large Intelligent Surfaces Assisted MIMO Communication.....N/A

M.S. Alouini¹, Q.A. Nadeem¹, A. Kammoun¹, A. Chaaban² and M. Debbah³ (Invited Talk)
¹King Abdullah University of Science and Technology (KAUST), Saudi Arabia, ²University of British Columbia, Canada, ³Huawei, France

S1-2 10:15-10:30

Towards Dynamic 5G Networks Utilizing Flexible Function Split.....1

Y. Alfadhli¹, P. C. Cheng², S. Shen¹, S. Yao¹, M.S. Omar¹, Y.W. Chen¹, S.M. Mitani³, and G.-K. Chang¹
¹Georgia Institute of Technology, USA, ²National Taipei University Taiwan, ³Tm R&D, Malaysia

S1-3 10:30-10:45

Reliable Multi-user Uplinks in Fiber-Wireless Integrated Network using Quasi-orthogonal Chirp Spreading OFDM.....4

You-Wei Chen¹, Peng-Chun Peng², Long Huang³, G.-K. Chang¹

¹Georgia Institute of Technology, USA, ²National Taipei University of Technology, Taiwan,

³Nanjing University, P.R. China

S1-4 10:45-11:05

Key Techniques for high-capacity 5G wireless networks.....N/A

P.-T. (Boris) Shih(Invited Talk) Corning, USA

S1-5 11:05-11:20

W-band PAM-4 wireless delivery employing intensity modulation and coherent detection based on CMMA equalization.....7

W. Zhou, L. Zhao, YW Chen, G.-K. Chang

Georgia Institute of Tech., USA

Luncheon Keynote Talk 11:30-13:00

5G and the Rise of Directive Communications: THE END OF THE MARCONI ERA IS NEAR

Gabriel M. Rebeiz

UC San Diego, CA, USA

Session 2: Mm-Wave to THz Circuits and Technologies

Chair: S. Shahramian, Bell Labs – Nokia, USA Date: Thursday, 15th August 2019

S2-1 13:15-13:40

300-GHz-Band CMOS Transmitter and Receiver Modules with WR-3.4 Waveguide Interface.....10

S. Amakawa, M. Fujishima (Invited Talk)

Hiroshima Univ., Japan

S2-2 13:40-14:05

Sub-THz and THz Signal Generation Using Photonic and Electronic Techniques.....13

A. Banerjee¹, L. Zhang¹, H. Wang², P. Wambacq³ (Invited Talk) ¹imec USA, ²Georgia Inst. of Technology, USA, ³imec/VUB Belgium

S2-3 14:05-14:30

Packaging Approaches for mm-Wave and Sub-THz Communication.....16

S. Ravichandran, KQ Huang, FM Rehman, S. Erdogan, A. Watanabe, N. Nedumthakady, F. Liu, M. Kathaperumal, M. Swaminathan (Invited Talk)
Georgia Institute of Technology, USA

S2-4 14:30-14:45

High-Performance Optically Controlled RF Switches for Advanced Reconfigurable Millimeter-Wave-to-THz Circuits.....21

Yu Shi, Jun Ren, Y. Deng, P. Fay, L. Liu
Univ. of Notre Dame, USA

Session 3: Advanced RF PAs with Back-Off Enhancement Techniques

Chair: A. Zhu, University College Dublin, Ireland Date: Thursday, 15th August 2019

S3-1 15:00-15:15

Design and characterization of an outphasing power amplifier with balun combiner.....24

A. Bogusz¹, J. Lees¹, R. Quaglia¹, S. Cripps¹, G. Watkins² ¹Cardiff University, United Kingdom, ²Toshiba Research Europe

S3-2 15:15-15:30

Envelope Tracking for 5G Mobile Handsets.....27

J. Retz¹, N. Khlaf², J.-F. Chiron² ¹Qorvo USA, ²Qorvo France

S3-3 15:30-15:45

Linearity Characterizations of Highly Efficient, Infrastructure GaN Doherty Power Amplifier for 5G Applications.....30

M. Masood, S. Embar, P. Rashev
NXP Semiconductors, USA

S3-4 15:45-16:00

Linearity-aware design of Doherty power amplifiers.....33

A. Piacibello¹, R. Figueiredo², V. Camarchia¹, M. Pirola¹, N.B. Carvalho² ¹Politecnico di Torino, Italy, ²University of Aveiro, Portugal

Session 4: Mm-Wave to THz Circuits and Technologies

Chair: J. Sharma, Intel Labs, USA Date: Thursday, 15th August 2019

S4-1 16:15-16:40

Advanced Packaging and its Characterization for 5G mmWave Antenna in Package.....36

S.W. Lu, H.S. Cho, H. Chang (Invited Talk) Advanced Semiconductor Engineering, Taiwan

S4-2 16:40-16:55

**28-32 GHz Dual-Polarized Single-Layer Microstrip Line Beamforming Network for 2×2.....40
Beam**

N. Ashraf, A. Kishk, A.R. Sebak
Concordia Univ., Canada

S4-3 16:55-17:10

**Dual-Polarized Substrate-Integrated-Waveguide Cavity- Backed Monopulse Antenna
Array for 5G Millimeter-Wave Applications.....43**

C. Chu¹, J. Zhu², S. Liao³, Q. Xue³, A. Zhu¹

¹University College Dublin, Ireland, ²Beijing University of Posts and Telecom., China, ³South
China Univ. of Technology, China

S4-4 17:10-17:25

**Wideband Front-End Integration and Unification of Circuit- Antenna for Simultaneous
Stabilized Amplification and Steered Radiation.....46**

S. Nallandhigal, K. Wu
École Polytechnique de Montréal, Canada

Date: Friday, 16th August 2019

Keynote Talk 2 09:00-09:35

5G Radio: A perspective on Silicon Technologies and Solutions

A.Bandyopadhyay Globalfoundries, CA, USA

Keynote Talk 3 09:40-10:15

**ComSenTer: Pushing Frequency, Bandwidth, and Spectral Efficiency by 10X Cubed for
mm-Wave and Terahertz Arrays for Communication and Imaging Applications**

Ali M. Niknejad
UC Berkeley, CA, USA

Session 5: System Architectures and Algorithms for 5G Applications

Chair: Tim Lee, IEEE MTT-S, USA Date: Friday, 16th August 2019

S5-1 10:30-10:45

Flexible Architectures for Concurrent Reception of Multiple RF Carriers and Compressed-Sampling Signal Detection in Frequency and Direction-of-Arrival.....49

T. Haque, G. Han, M.

Bajor, J. Wright, P. Kinget

Columbia University, USA

S5-2 10:45-11:00

Linearizing Active Antenna Arrays: Digital Predistortion Method and Measurements.....52

A. Brihuega¹, M. Abdelaziz², M. Turunen¹, T. Eriksson³, L. Anttila¹, M. Valkama¹ ¹Tampere University of Technology, Finland, ²Zewail City of Science and Tech., Egypt, ³Chalmers University of Technology, Sweden

S5-3 11:00-11:15

Digital Cancellation of Passive Intermodulation: Method, Complexity and Measurements.....55

M. Waheed¹, D. Korpi², A. Kiayani³, L. Anttila³, M. Valkama³

¹Nokia Mobile Networks, Finland, ²Nokia Bell Labs, Finland, ³Tampere University, Finland

S5-4 11:15-11:30

Pattern Sensing Based Digital Predistortion of RF Power Amplifiers under Dynamical Signal Transmission.....58

H. Yin¹, C. Yu¹, Q. Lu¹, J. Xia², X. Zhu¹, W. Hong¹, A. Zhu³

¹Southeast University, China, ²Jiangsu University, China, ³University College Dublin, Ireland

S5-5 11:30-11:45

Phase Calibration of a Massive MIMO System for Direction of Arrival Applications.....61

M.D. Al-Dabbagh¹, A. Gaber², A. Omar¹

¹University of Magdeburg, Germany, ²National Instruments, Germany

S5-6 11:45-12:00

Parallel-Processing-Based Digital Predistortion Architecture and FPGA Implementation for Wide-band 5G Transmitters.....64

H. Huang, J. Xia, S. Boumaiza

University of Waterloo, Canada

S5-7 12:00-12:15

88.9-GHz W-Band Multi-Channel Integrated Fiber-Wireless Access Network with KK Coherent Receiver.....67

S. J. Su, Y. W. Chen, S. Shen, G.-K. Chang.
Georgia Institute of Technology, USA

Circuits Techniques for High-Performance Frontends

Chair: Chair: Gee-Kung Chang, Georgia Institute of Technology, USA Date: Friday, 15th August 2019

S6-1 13:15-13:40

Sub-Sampling PLL For Millimeter Wave Applications: An Overview.....70

Xiang Gao (Invited Talk) Zhejiang University, P.R. China

S6-2 13:40-13:55

An Integrated 28 GHz Front-End Module for 5G Applications in 45 nm PD-SOI.....75

R. Ciocoveanu^{1,2}, V. Lammert^{1,2}, R. Weigel², V. Issakov¹
¹Infineon Technologies, Germany, ²University of Erlangen, Germany

S6-3 13:55-14:10

A 9-Bit Vector-Sum Digital Phase Shifter Using High Resolution VGAs and Compensated Quadrature Signal Generator.....78

J. Zhou, H. Qian, X. Luo
University of El. Science and Tech., China

S6-4 14:10-14:25

A 27-29GHz Integer-N PLL with Quadrature phases for 5G applications.....81

V. Aggarwal¹, S. Aniruddhan² ¹Cadence, India, ²Indian Ins. Tech.

S6-5 14:25-14:40

Approaches to Nonoverlapping Clock Generation for RF to Millimeter-Wave Mixer-First Receivers.....84

S. Hari, A. Bhat, C. Wilson, B. Floyd
NC State Univ., USA

Session 7: Mm-Wave Power Amplifiers

Chair: Jim Buckwalter, UC Santa Barbara, USA Date: Friday, 16th August 2019

S7-1 14:50-15:15

High-Efficiency Stacked Cell CMOS SOI Power Amplifiers for 5G Applications.....87

S. Mohammadi (Invited Talk) Purdue University, USA

S7-2 15:15-15:30

An Artificial-Intelligence (AI) Assisted Mm-Wave Doherty Power Amplifier with Rapid Mixed-Mode In-Field Performance Optimization.....91

F. Wang, K. S. Xu, J. K. Romberg, H. Wang
Georgia Inst. Tech., USA

S7-3 15:30-15:45

A 21 to 31 GHz Multi-Stage Stacked SOI Power Amplifier with 33% PAE and 18 dBm Output Power nodes.....94

T. Ren, B. Floyd
North Carolina State University, USA

S7-4 15:45-16:00

High Power Ka Band Amplifier Using Multigate Structure With Capacitive Feedback in CMOS-SOI.....97

N. Rostomyan¹, T. Torii², S. Alluri¹, P. Asbeck¹
¹UCSD, ²Mitsubishi

S7-5 16:00-16:15

Implementation of a Differential Mm-Wave CMOS SOI Power Amplifier.....100

J. Peterson, S. Mohammadi Purdue University, USA

Closing Session

Date: Friday, 16th August 2019

Closing Remarks 16:15-16:30

Poster Papers

Date: Thursday, 15th August 2019

P-1

W-band low-power millimeter-wave direct down converter using SiGe HBTs in saturation region.....103

A. Mukherjee, M. Schroter
Technische Universität Dresden, Germany

P-2

5G mm-Wave SPDT Switch IMDn Investigation.....106

K. Barnett Globalfoundries, USA

P-3

Behavioral Modeling of Power Amplifiers With Modern Machine Learning Techniques.....109

S. Dikmese, L. Anttila, P. P. Campo, M. Valkama, M. K. Renfors Tampere University of Technology, Finland

P-4

Resilient Mobile Fronthaul Links with Heterodyne Detection in Integrated Fiber-MMW-Fiber Transmission.....112

R. Zhang, Y. Chen, S. Liu, Y. Alfadhli, Y. Tang, G.-K. Chang
Georgia Institute of Technology, USA

P-5

A compact, 42% PAE, two-stage, LDMOS Doherty PA Module for Massive MIMO Applications.....115

H. Ladhani, E. Maalouf, J. Jones, M. Masood, and J. S. Kenney
NXP Semiconductors, USA and Georgia Institute of Technology, USA

P-6

A 180 GHz High-Gain Cascode Amplifier in 130-nm SiGe process.....118

X. Li, W. Chen, Z. Feng Tsinghua University, P.R. China

P-7

3D Glass-Based Panel-Level Package with Antenna and Low-Loss Interconnects for Millimeter- Wave 5G Applications.....121

A. Watanabe, M. Swaminathan, R. Tummala, M. M. Tentzeris
Georgia Institute of Technology, USA